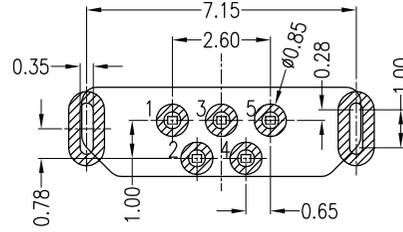
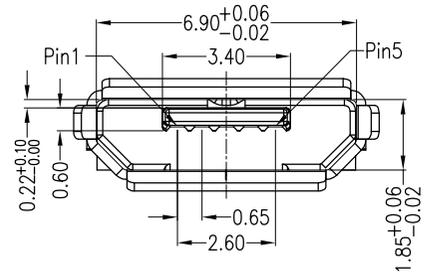
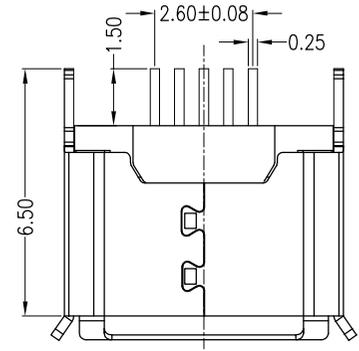
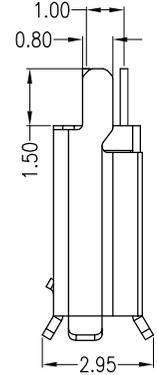
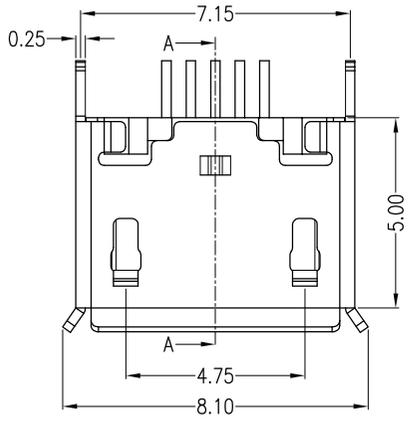
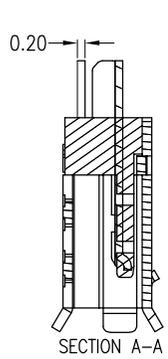
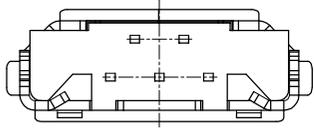


REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE



RECOMMENDED PCB LAYOUT
PCB图仅供参考

Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.20mm
- 1.3 Shell: SUS304,t=0.25mm

2.Specification:

- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

PART NO: TCB0010		MATERIAL: SEE NOTE		连兴旺电子(深圳)有限公司 LXWCONN ELECTRONICS (SHENZHEN) CO., LTD	
MODEL NO: XX		FINISH: SEE NOTE			
UNIT: MM	SIZE: A4	COLOR: SEE NOTE		TITLE: Micro usb 5s B型180度插板脚长1.5	
TOLERANCE UNSPECIFIED		DR: xiayouhong		DWG NO: A678	
.x	0.15	CHK:		REV: A	
.xx	0.10	APP:		SCALE: 5:1	
.xxx	0.05			DATE: 2016.06.18	
Ang.	1°				